



DMN1250UFEL

N-CHANNEL ENHANCEMENT MODE MOSFET

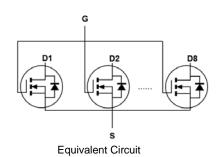
Features

- Low Gate Charge
- $R_{DS(ON)}$: 280m Ω @ V_{GS} = 4.5V (Single MOSFET)
- 8 N-Channel MOSFET in One Package
- Common Source
- Small Footprint 1.5mm × 1.5mm
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-QFN1515-12
- Case Material—Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (C3)
- Terminal Connections: See Diagram
- Weight: 0.004 grams (Approximate)

Bottom View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1250UFEL-7	U-QFN1515-12	3000/Tape & Reel

U-QFN1515-12

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Notes:

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-QFN1515-12



A1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 8 = August)

Year	2014		2015	2016		2017	2018		2019	2020		2021
Code	В		С	D		E	F		G	Н		I
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	12	V
Gate-Source Voltage		V _{GSS}	±8	V
Drain Current (Note 6) Continuous	T _A = +25°C T _A = +70°C	ID	2.0 1.6	A
Pulsed Drain Current (Note 7)		I _{DM}	10	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	0.66	W
Total Power Dissipation (Note 6)	PD	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	177	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	100	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

Notes:

Device mounted on 1" x 1", FR-4 PC board with minimum recommended pad layout, and test with single MOSFET.
Device mounted on 1" x 1", FR-4 PC board with 2 oz. copper, and test with single MOSFET.
Repetitive Rating, pulse width limited by junction temperature, and test with single MOSFET.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

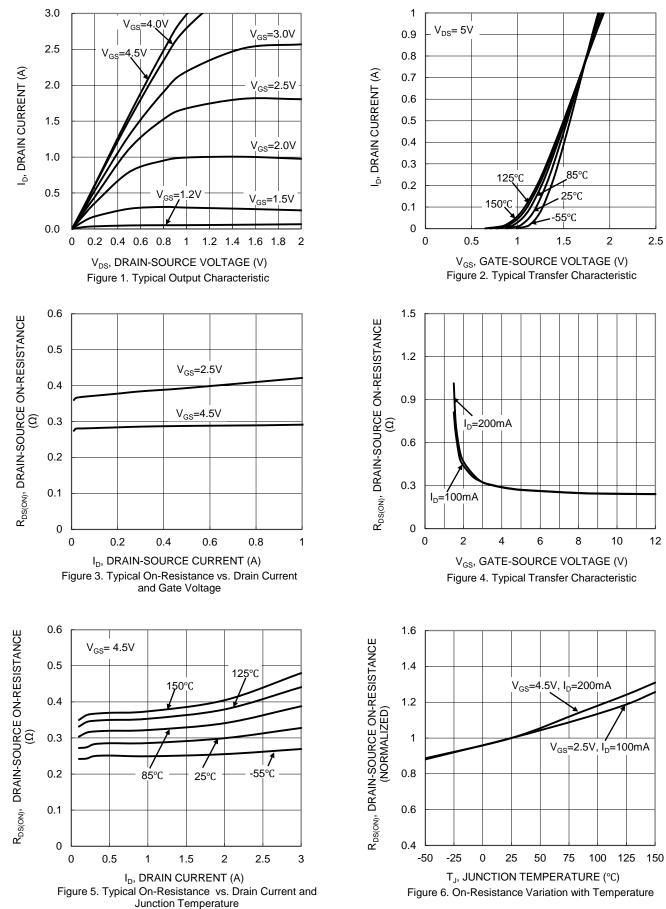
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
STATIC CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	12	—	—	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	$V_{DS} = 12V, V_{GS} = 0V$	
Gate-Body Leakage Current	I _{GSS}		_	±100	nA	$V_{DS} = 0V, V_{GS} = \pm 8V$	
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
	_		280	450	mΩ	V _{GS} = 4.5V, I _D = 0.2A	
Static Drain-Source On-Resistance (Note 8)	R _{DS(ON)}		360	550	mΩ	V _{GS} = 2.5V, I _D = 0.1A	
Forward Transfer Admittance	Y _{FS}		1	_	S	$V_{DS} = 6V, I_D = 0.2A$	
Diode Forward Voltage (Note 8)	V _{SD}		0.8	1.0	V	$I_{S} = 0.2A, V_{GS} = 0V$	
DYNAMIC CHARACTERISTICS (Note 9)			•			•	
Input Capacitance	C _{iss}		146	190	pF	V _{DS} = 6V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	—	10	15	pF		
Reverse Transfer Capacitance	Crss	—	8	13	pF		
Gate Resistance	R _G	_	2.4	—	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$	
SWITCHING CHARACTERISTICS (Note 9)			•	•	•	•	
Total Gate Charge	Qg	_	1.3	1.9	nC		
Gate-Source Charge	Q _{gs}	—	0.3	_	nC	$V_{GS} = 4.5V, V_{DS} = 6V, I_D = 0.2A$	
Gate-Drain Charge	Q _{gd}	_	0.1	—	nC		
Turn-On Delay Time	t _{D(ON)}		1.9	2.7	nS		
Turn-On Rise Time	t _R	-	1.3	—	nS	$V_{DD} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	7.5	11	nS	$R_L = 22\Omega, R_G = 6\Omega$	
Turn-Off Fall Time	t _F	—	1.0	—	nS		

Notes:

Test pulse width t = 300ms, test with single MOSFET.
Guaranteed by design with single MOSFET, not subject to production testing.

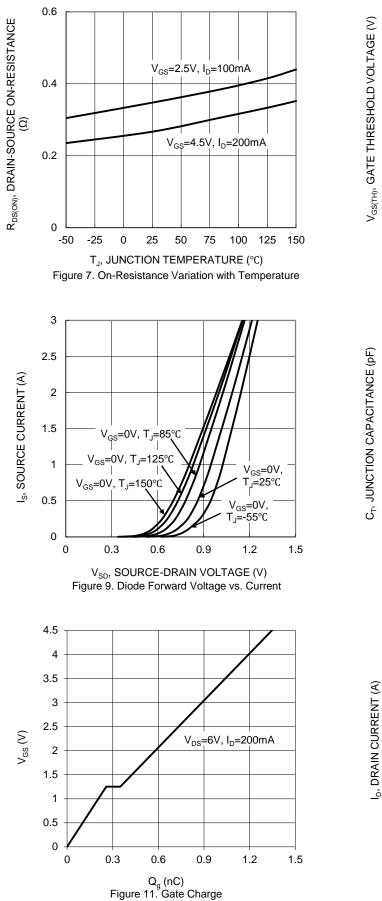


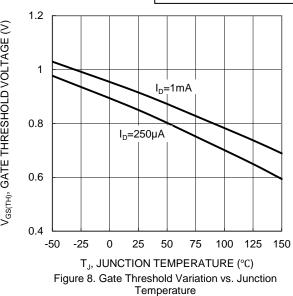
DMN1250UFEL





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1000 f=1MHz C_{iss} 100 Coss 10 Crss 1 0 6 8 2 4 10 12 $\mathsf{V}_{\mathsf{DS}},$ DRAIN-SOURCE VOLTAGE (V)

Figure 10. Typical Junction Capacitance

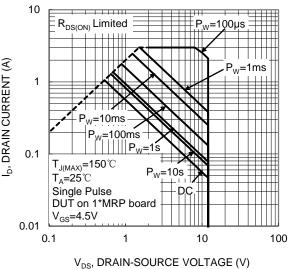


Figure 12. SOA, Safe Operation Area



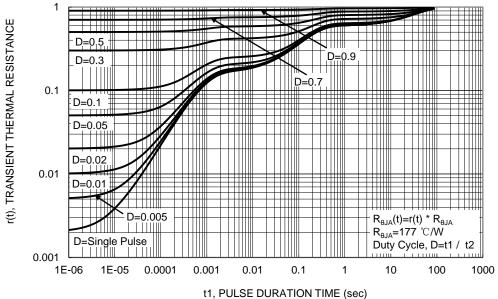
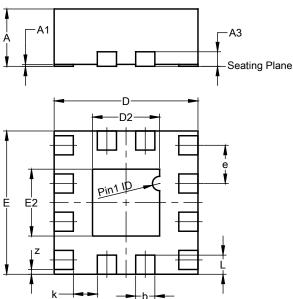


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

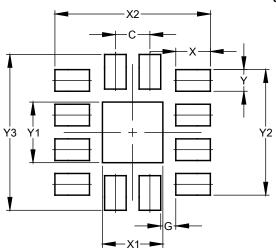
Please see http://www.diodes.com/package-outlines.html for the latest version.



	U-QFN1515-12							
Dim	Min	Мах	Тур					
Α	0.57	0.63	0.60					
A1	0.00	0.05	0.02					
A3	0.	152 BS	С					
b	0.15	0.25	0.20					
D	1.45	1.55	1.50					
D2	0.60	0.80	0.70					
E	1.45	1.55	1.50					
E2	0.60	0.80	0.70					
е	0.40 BSC							
L	0.15	0.25	0.20					
k	_	_	0.25					
z	_	_	0.050					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



U-QFN1515-12

Dimensions	Value (in mm)
С	0.400
G	0.175
Х	0.400
X1	0.700
X2	1.800
Y	0.250
Y1	0.700
Y2	1.450
Y3	1.800

U-QFN1515-12



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